

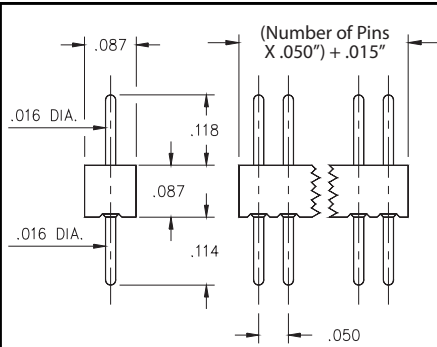


Fig. 1

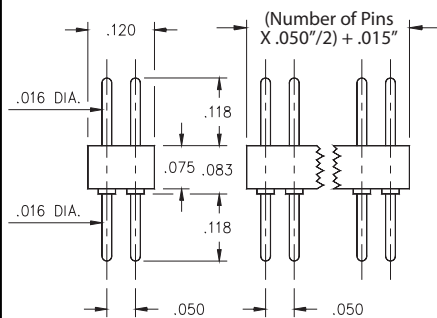


Fig. 2

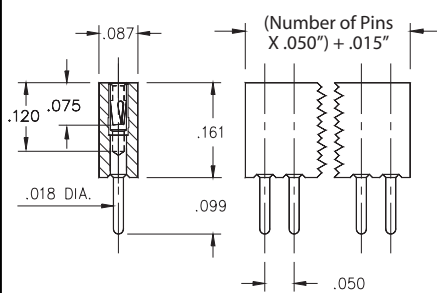


Fig. 3

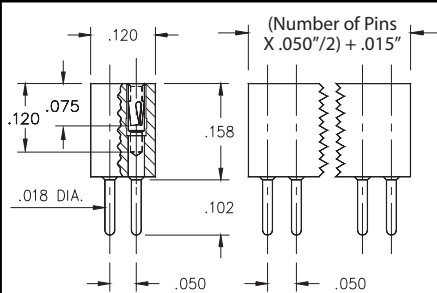


Fig. 4

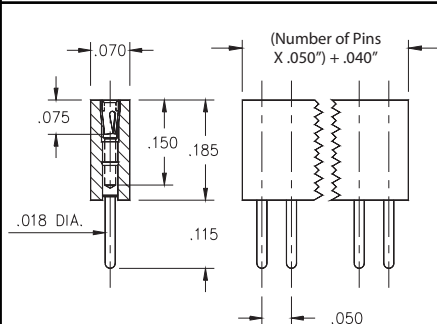
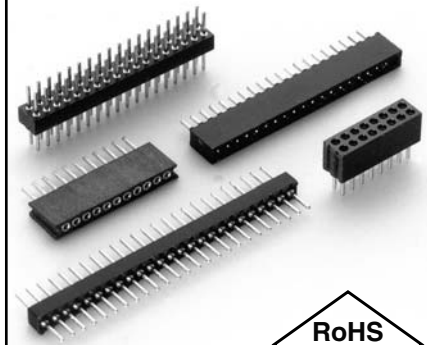


Fig. 5

- Series 850 single and double row interconnects have .050" pin spacing & permit board stacking as low as .248".
- Pin headers have .016" dia. pins (MM #4006-0). See page 175 for details.
- MM #0467 and MM #4890 receptacles use Hi-Rel, 3-finger BeCu #11 contacts rated at 3 amps. (#11 contact accepts pin diameters from .015"-.020"). See pages 129 and 131 for details.
- Insulators are high temp. thermoplastic, suitable for all soldering operations.



Ordering Information

Fig. 1	Single Row .087" Profile Pin Header
	850-XX-0_-10-001000 Specify # of pins → 01-50

Fig. 2	Double Row .075" Profile Pin Header
	852-XX-_-10-001000 Specify # of pins → 002-100

For Electrical,
Mechanical & Environmental
Data, See pg. 4

XX=Plating Code
See Below

For RoHS compliance
select ◇ plating code.

SPECIFY PLATING CODE XX=	10◇	90	40◇	
Pin Plating	10μ" Au	200μ" Sn/Pb	200μ" Sn	

Fig. 3	Single Row .161" Profile Socket
	851-XX-0_-10-001000 Specify # of pins → 01-50

Fig. 4	Double Row .161" Profile Socket
	853-XX-_-10-001000 Specify # of pins → 002-100

Fig. 5	Single Row .185" Profile Socket
	851-XX-0_-10-002000 Specify # of pins → 01-77

For Electrical,
Mechanical & Environmental
Data, See pg. 4

XX=Plating Code
See Below

For RoHS compliance
select ◇ plating code.

SPECIFY PLATING CODE XX=		93	99		43◇	
Sleeve (Pin)		200μ" Sn/Pb	200μ" Sn/Pb		200μ" Sn	
Contact (Clip)		30μ" Au	200μ" Sn/Pb		30μ" Au	